



September 4, 2024

86th Issuance of Domestic Unsecured Straight Bonds

ACOM CO., LTD. has reached a decision to make its 86th issuance of domestic unsecured straight bonds, as outlined below. The funds procured through this issuance will be used for redemption of bond and partial repayment of long-term borrowings.

Name of issuance	ACOM CO., LTD. 86 th issuance of domestic unsecured straight bonds
Total value	25 billion yen
Interest rate	0.788% annually
Individual bond value	100 million yen
Issue price	Face value 100 yen
Redemption price	Face value 100 yen
Application period	September 4, 2024
Payment date	September 10, 2024
Maturation date	September 10, 2027
Application of funds procured	Redemption of bond and partial repayment of long-term borrowings
Trustee	Mitsubishi UFJ Morgan Stanley Securities Co., Ltd. SMBC Nikko Securities Inc. Daiwa Securities Co. Ltd. Nomura Securities Co., Ltd.
Transfer agent	MUFG Bank, Ltd.
Credit ratings	Rating and Investment Information, Inc.: AA-

ACOM CO., LTD.

Tokyo Shiodome Bldg., 1-9-1, Higashi-Shinbashi, Minato-ku, Tokyo, Japan